



PARA LIGHT ELECTRONICS CO., LTD.

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DATA SHEET

PART NO.: L-T2835IR4CT-60-JH

REV: <u>A / 2</u>

CUSTOMER'S APPROVAL:

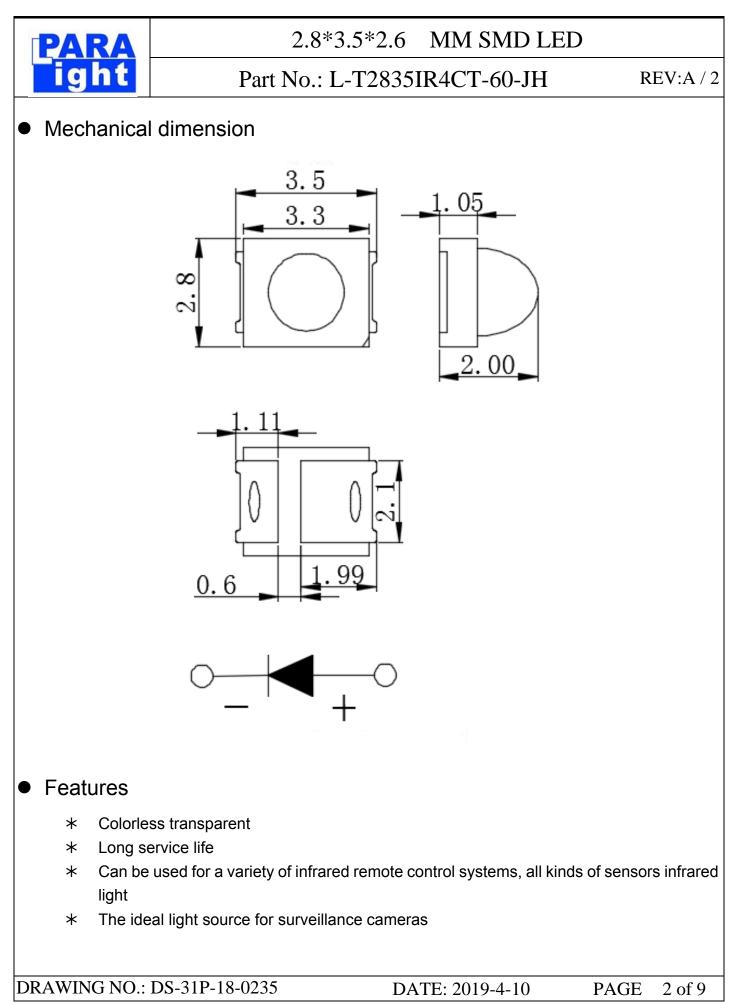
DRAWING NO.: DS-31P-18-0235

_____ DCC: DATE: 2019-4-10

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PARA-FOR-065







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● Absolute Maximum Ratings at (Ta=25°C)

ITEMS	SYMBOL	ABSOLUTE MAXIMUM RATING	UNIT
Maximum Current	I _F	250	mA
Pulse Current	I _{FP}	200	mA
Reverse Voltage	V _R	5	V
Power Dissipation	PD	300	mW
Operation Temperature	T _{opr}	-40 ~ + 100	°C
Storage Temperature	T _{stg}	-40 ~ + 100	°C
Junction temperature	Tj	120	°C
Soldering	Tsol	260	°C
temperature Manual soldering time at 260°C(max)		5	sec

Notes:

- 1. Proper current rating must be observed to maintain junction temperature below the maximum at all time.
- 2. IFM condition: 0.1 ms pulse width, Duty Cycle=0.25.
- 3. All above test condition: Mounted on PC Board FR 4(pad size>=16mm2)
- 4. LED lamps are not designed to be driven in reverse bias.

• Typical Electrical & Optical Characteristics (Ta = 25°C)

Items	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	V _F	I _F =150mA	1.2		1.7	V
Reverse Current	I _R	V _R = 5V			5	А
Light power	Φν	I _F =150mA	80		140	Mw/sr
peak wavelength	WP	I _F =150mA		850		NM
Power (Avg)	Р	I _F =150mA		230		mw
Light Angle	201/2	IF=150mA		60		deg
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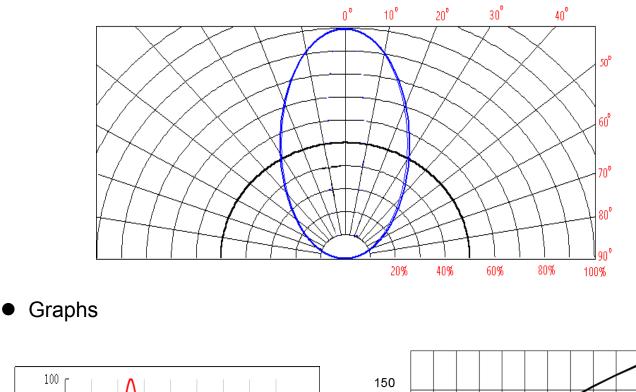
Part No.: L-T2835IR4CT-60-JH

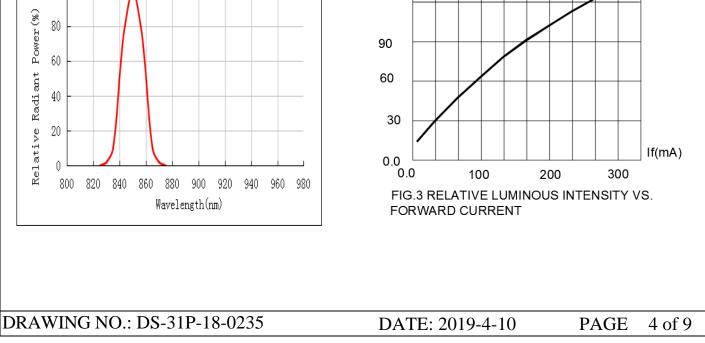
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Notes:

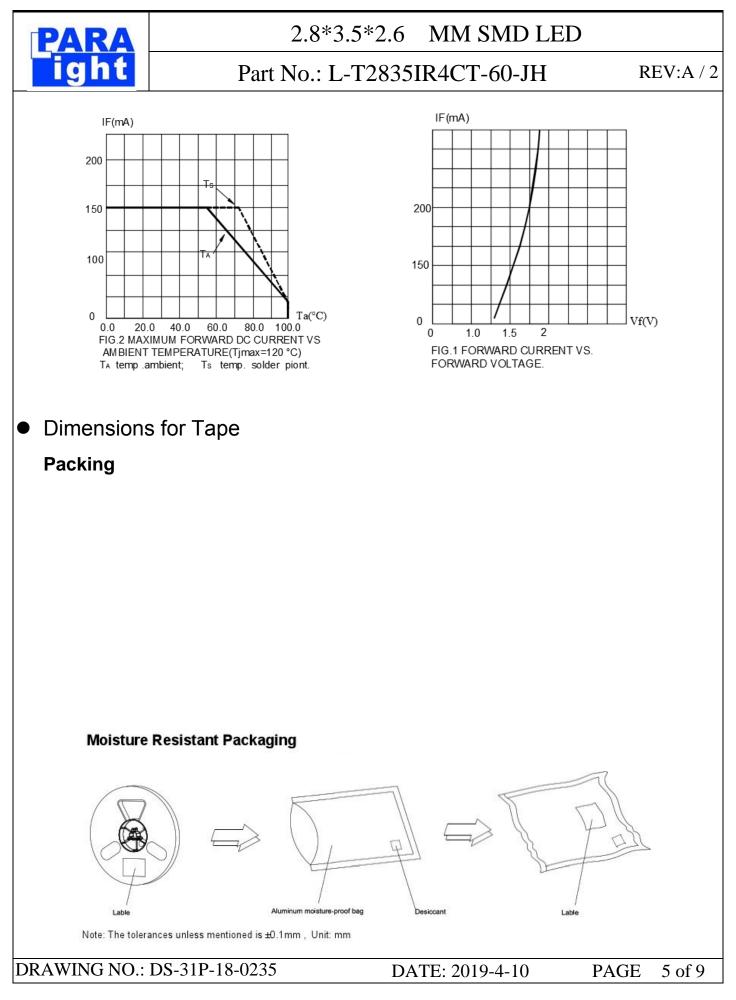
- 1) Tolerance of measurement of the Color Coordinates is ±0.01.
- 2) Tolerance of measurement of Vf is ±0.05.
- 3) Luminous Flux is measured with the accuracy of ±10%.

Light Angle •





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Notes:

1. All dimensions are in mm, tolerance is±2.0mm unless otherwise noted.

2. Specifications are not subject to change without notice.

• Reliability Testing for SMD

Туре	Test Item	REF. Standard	Test condition	Times	Sample count
Environments Sequence	Temperature Cycle	JESD22-A104 -A	-40℃~25℃~100℃~ 25℃ 30min,5min,30min,5min	100 cycles	100
	Thermal shock (冷热冲击)	JESD22-A106	-40℃~100℃ 30min,30min	100 cycles	100
	Temperat ure Storage	JIS C 7021 (1977)B-11	Ta=60℃ RH=90%	1000Hrs	100
Operation Sequence	Life test	JESD22-A108-A	Ta=25℃	1000Hrs	100
	High humidity Heat life test	JESD22-A101	Ta =85℃ RH=85% If: B=150mA	1000Hrs	100
Destructive Sequence	Resistance to soldering Heat	JESD22-A113	IR soldering 245℃	10Sec	20
			/10sec		
ESD Test	ESD TEST	AEC(Q101-002)	Human body model		10
			2000v		
Physical Sequent	Physical	MIL-STD-883 Method 2007	20G min ,20 to 2000Hz 4 cycles,4min.Each,X,Y,Z		50
	Sequence				

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Application notes

The purpose of this document is to provide a clear understanding to the customers and users, on the ways how to use our LED lamps appropriately

Description

Generally, LED can be used the same way as other general-purpose semiconductors. When using VANTEX'S Lamps, the following precautions must be taken to protect the LED.

1.Cleaning

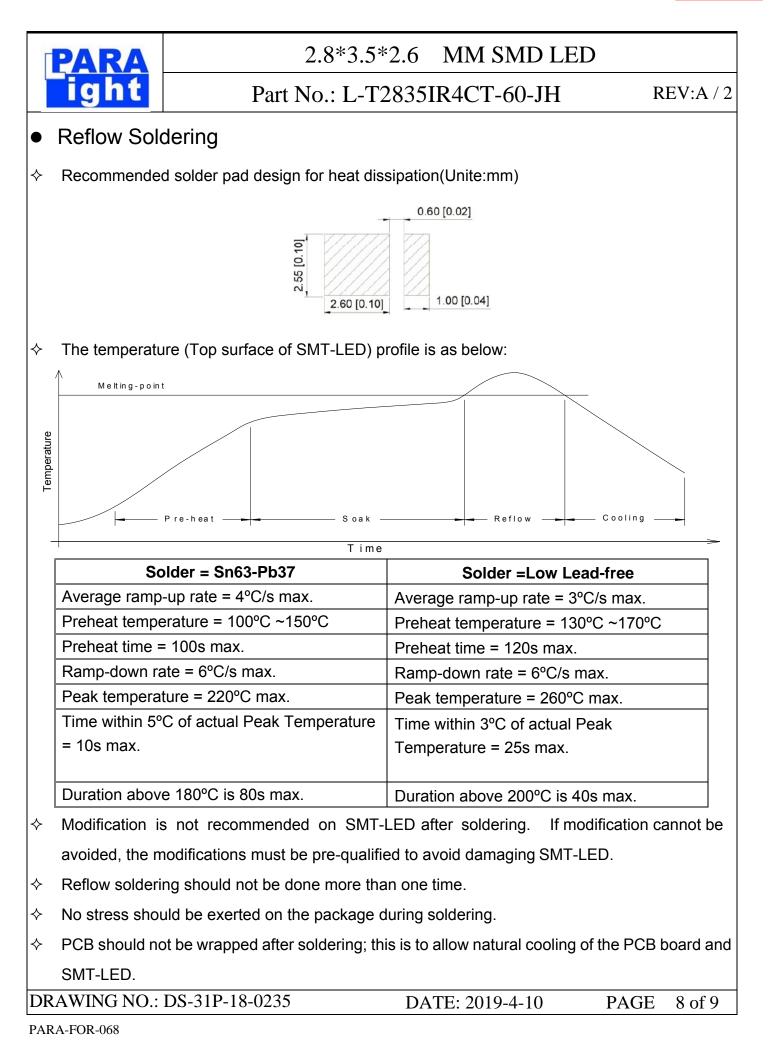
Don't use unspecified chemical liquids to clean the SMT-LED; the chemical could harm the SMT-LED. When washing is necessary, please immerse the SMT-LED in alcohol at normal room temperature for less than 1 minute and dry at normal room temperature for 15 minutes before use. The influence of ultrasonic cleaning on the SMT-LED depending on factors such as ultrasonic power and the way SMT-LED are mounted. Ultrasonic cleaning shall be pre-qualified to ensure this will not cause damage to the SMT-LED.

2.Moisture Proof Packing

In order to prevent moisture absorption into SMT-LED during the transportation and storage, SMT-LED is packed in a moisture barrier bag. Desiccants and a humidity indicator are packed together with SMT-LED as the secondary protection. The indication of humidity indicator card provides the information of humidity within SMD packing.

- (1) Shelf life in original sealed bag at storage condition of <40°C and <90%RH is 6 months. Baking is required whenever shelf life is expired
- (2) After bag opening, the SMT-LED must be stored under the condition < 30°C and < 60%RH. Under this condition, SMT-LED must be used (subject to reflow) within 8 hours after bag opening, and re-baking is required when exceeding 12 hours. For baking, place SMT-LED in oven at temperature 80±5°C and relative humidity <=10%RH, for 12 hours.</p>
- 3.Soldering .(Manual soldering by soldering iron)

The use of a soldering iron of less than 25W is recommended and the temperature of the iron must be kept at below 315°C, with soldering time within 2 seconds. The silicone sealant of SMT-LED should not be in contact with tip of soldering iron. No mechanical stress should be exerted on the resin portion of SMT-LED during soldering. Handling of SMT-LED should be done when the package has been cooled down to below 40°C or less. This is to prevent the SMT-LED failures due to thermal-mechanical stress during handling.







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• Electrostatic Discharge and Surge current

- Electrostatic discharge (ESD) or surge current (EOS) may damage SMT-LED. Precautions such as ESD wrist strap, ESD shoe strap or antistatic gloves must be worn whenever handling of SMT-LED.
- ♦ All devices, equipment and machinery must be properly grounded.
- It is recommended to perform electrical test to screen out ESD failures at final inspection. It is important to eliminate the possibility of surge current during circuitry design.

Heat Management

Heat management of SMT-LED must be taken into consideration during the design stage of SMT-LED application. The current should be de-rated appropriately by referring to the de-rating curve attached on each product specification.